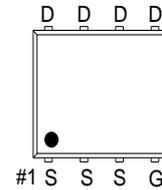
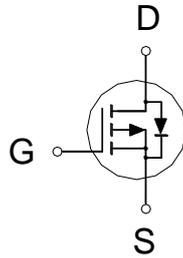


**PRODUCT SUMMARY**

$V_{(BR)DSS}$	$R_{DS(ON)}$	$I_D$
-20V	9.5mΩ	-34A



G : GATE  
D : DRAIN  
S : SOURCE

**ABSOLUTE MAXIMUM RATINGS ( $T_A = 25\text{ °C}$  Unless Otherwise Noted)**

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		$V_{DS}$	-20	V
Gate-Source Voltage		$V_{GS}$	±8	V
Continuous Drain Current <sup>3</sup>	$T_C = 25\text{ °C}$	$I_D$	-34	A
	$T_C = 100\text{ °C}$		-21	
	$T_A = 25\text{ °C}$		-12	
	$T_A = 70\text{ °C}$		-9.8	
Pulsed Drain Current <sup>1</sup>		$I_{DM}$	-100	
Avalanche Current		$I_{AS}$	-39	
Avalanche Energy	L = 0.1mH	$E_{AS}$	76	mJ
Power Dissipation	$T_C = 25\text{ °C}$	$P_D$	17.8	W
	$T_C = 100\text{ °C}$		7	
	$T_A = 25\text{ °C}$		2.3	
	$T_A = 70\text{ °C}$		1.5	
Junction & Storage Temperature Range		$T_j, T_{stg}$	-55 to 150	°C

**THERMAL RESISTANCE RATINGS**

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient <sup>2</sup>	$R_{\theta JA}$		54	°C / W
Junction-to-Case	$R_{\theta JC}$		7	

<sup>1</sup>Pulse width limited by maximum junction temperature.

<sup>2</sup>The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25\text{ °C}$ .

<sup>3</sup>Package limitation current is 22A

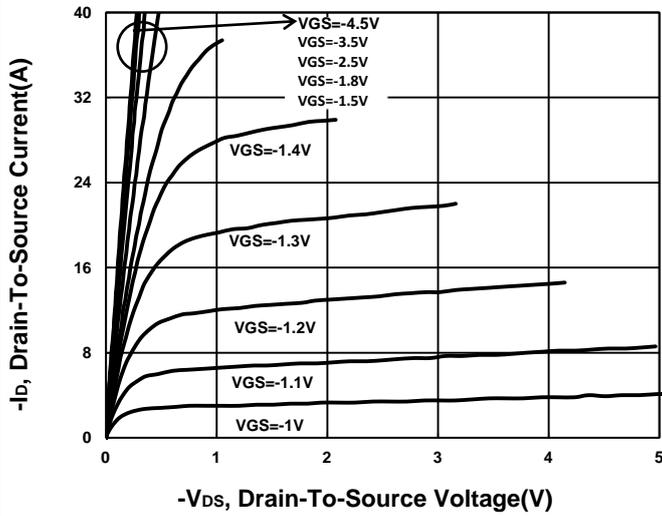
**ELECTRICAL CHARACTERISTICS (T<sub>J</sub> = 25 °C, Unless Otherwise Noted)**

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT	
			MIN	TYP	MAX		
<b>STATIC</b>							
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250μA	-20			V	
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250μA	-0.3	-0.6	-1		
Gate-Body Leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0V, V <sub>GS</sub> = ±8V			±100	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = -16V, V <sub>GS</sub> = 0V			-1	μA	
		V <sub>DS</sub> = -10V, V <sub>GS</sub> = 0V, T <sub>J</sub> = 55 °C			-10		
Drain-Source On-State Resistance <sup>1</sup>	R <sub>DS(ON)</sub>	V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -12A		7.3	9.5	mΩ	
		V <sub>GS</sub> = -2.5V, I <sub>D</sub> = -12A		8.8	12.5		
		V <sub>GS</sub> = -1.8V, I <sub>D</sub> = -11A		11	18		
Forward Transconductance <sup>1</sup>	g <sub>fs</sub>	V <sub>DS</sub> = -10V, I <sub>D</sub> = -12A		60		S	
<b>DYNAMIC</b>							
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0V, V <sub>DS</sub> = -10V, f = 1MHz		4480		pF	
Output Capacitance	C <sub>oss</sub>			429			
Reverse Transfer Capacitance	C <sub>rss</sub>			326			
Gate Resistance	R <sub>g</sub>	V <sub>GS</sub> = 0V, V <sub>DS</sub> = 0V, f = 1MHz		4		Ω	
Total Gate Charge <sup>2</sup>	Q <sub>g(VGS=-4.5V)</sub>	V <sub>DS</sub> = -10V, I <sub>D</sub> = -12A		46		nC	
	Q <sub>g(VGS=-2.5V)</sub>			26			
Gate-Source Charge <sup>2</sup>	Q <sub>gs</sub>			6.6			
Gate-Drain Charge <sup>2</sup>	Q <sub>gd</sub>			10			
Turn-On Delay Time <sup>2</sup>	t <sub>d(on)</sub>		V <sub>DD</sub> = -10V I <sub>D</sub> ≅ -12A, V <sub>GS</sub> = -4.5V, R <sub>GEN</sub> = 6Ω		32		nS
Rise Time <sup>2</sup>	t <sub>r</sub>				31		
Turn-Off Delay Time <sup>2</sup>	t <sub>d(off)</sub>				196		
Fall Time <sup>2</sup>	t <sub>f</sub>			125			
<b>SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T<sub>J</sub> = 25 °C)</b>							
Continuous Current	I <sub>S</sub>				-14	A	
Forward Voltage <sup>1</sup>	V <sub>SD</sub>	I <sub>F</sub> = -12A, V <sub>GS</sub> = 0V			-1.2	V	
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = -12A, dI/dt = 100A/μs		12.8		nS	
Reverse Recovery Charge	Q <sub>rr</sub>			4.5		nC	

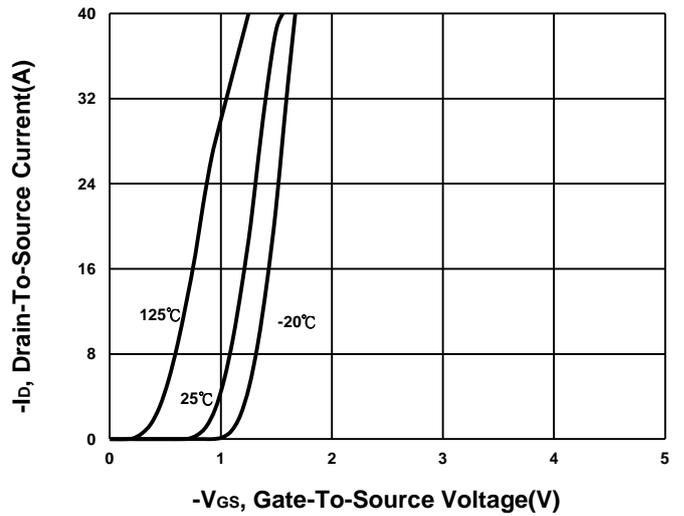
<sup>1</sup>Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

<sup>2</sup>Independent of operating temperature.

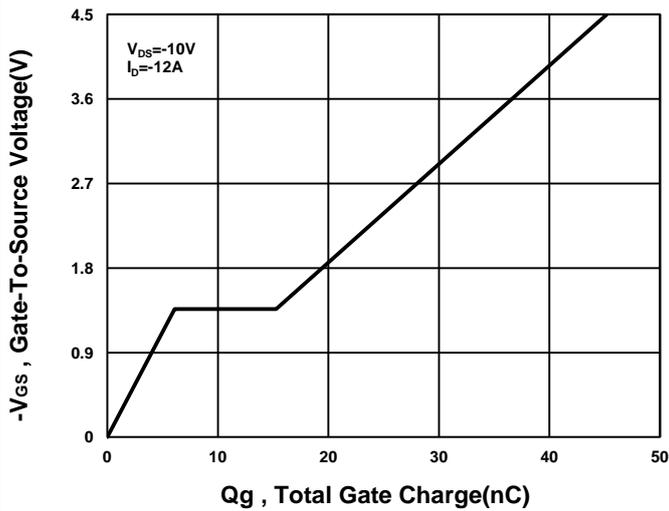
**Output Characteristics**



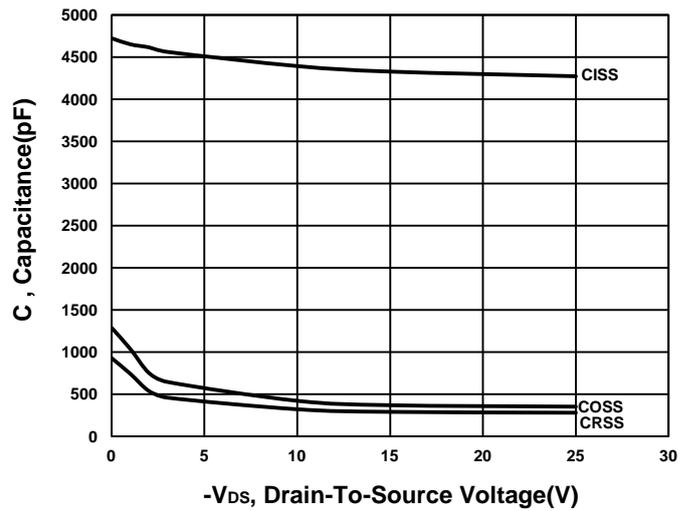
**Transfer Characteristics**



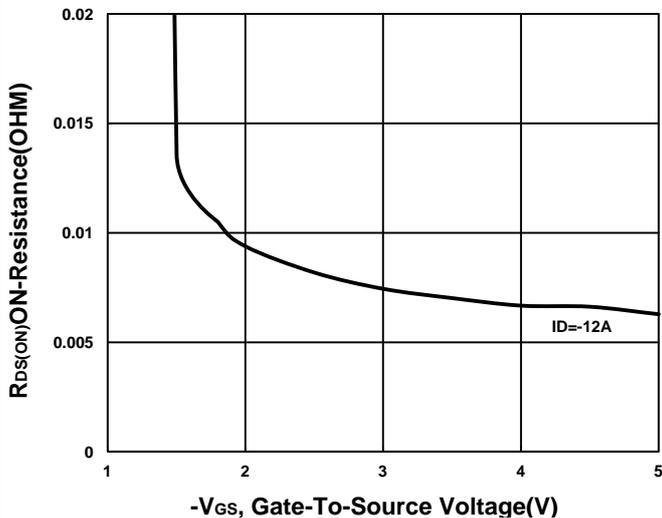
**Gate charge Characteristics**



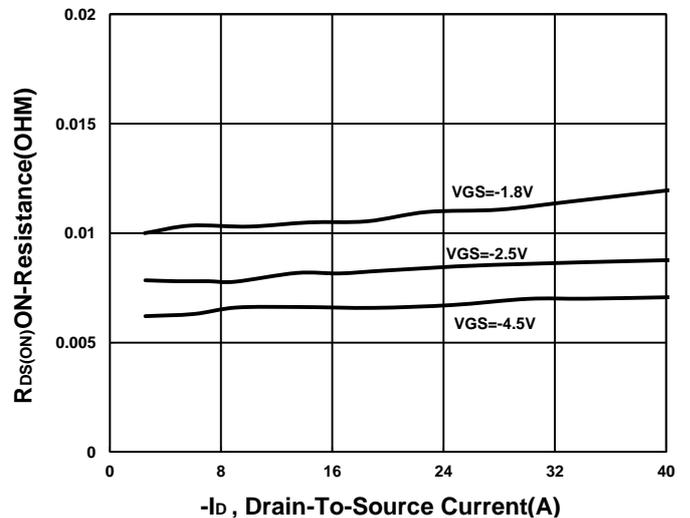
**Capacitance Characteristic**



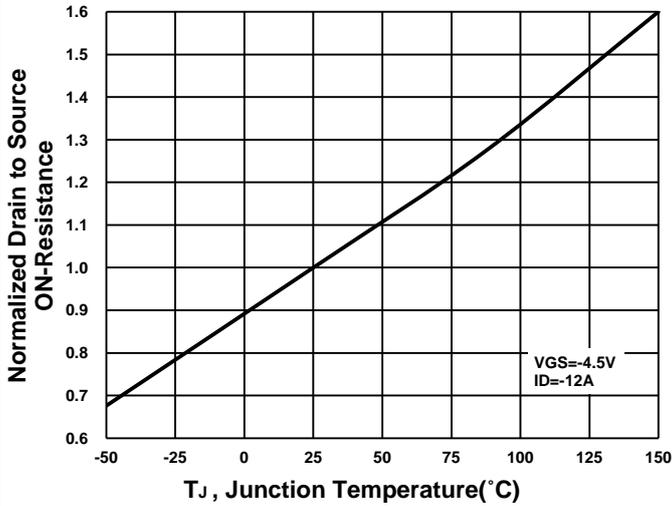
**On-Resistance VS Gate-To-Source**



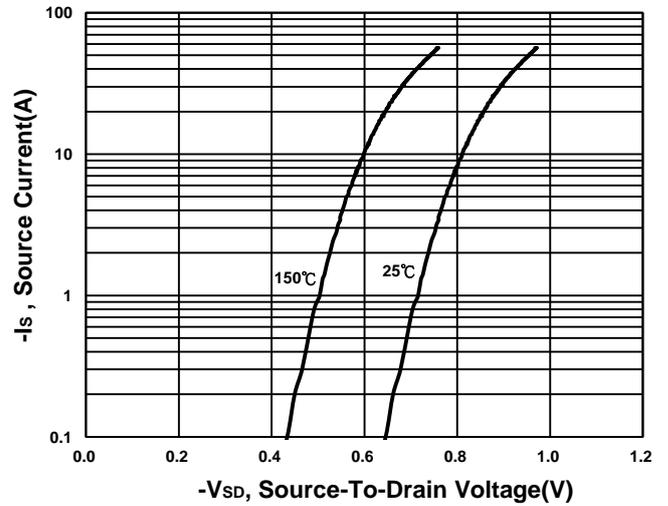
**On-Resistance VS Drain Current**



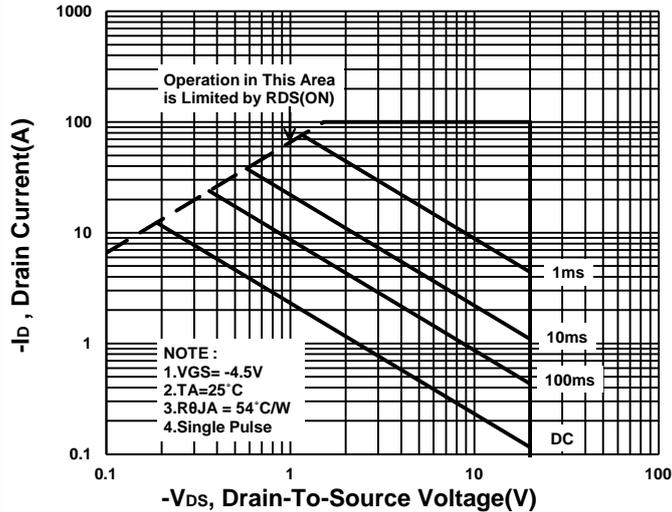
**On-Resistance VS Temperature**



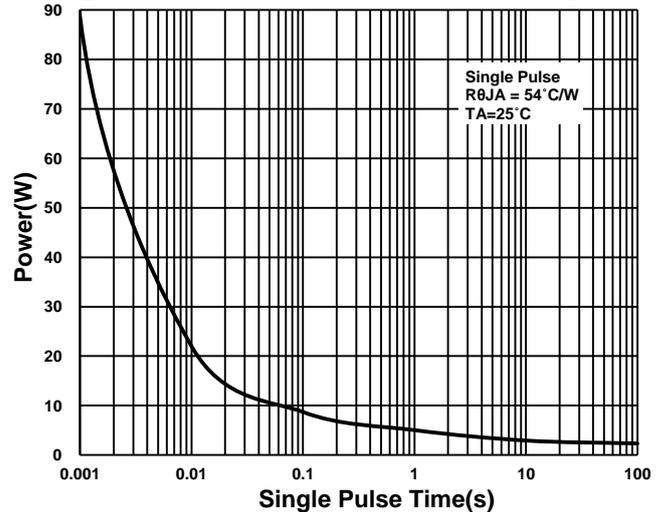
**Source-Drain Diode Forward Voltage**



**Safe Operating Area**



**Single Pulse Maximum Power Dissipation**



**Transient Thermal Response Curve**

